

External_Type	Material_Group	Substances	CAS_Number	Mass	Mass_Percentage_in_Leaf	Massmg
Die		Silicon Carbide (SiC)	409-21-2	0.24	100.0	1.11
			Subtotal	0.24	100	1.11
Wire	Pure metal	Aluminium (Al)	7429-90-5	0.23	100.0	1.05
			Subtotal	0.23	100	1.05
Lead Frame	Copper alloy	Phosphorous (P)	7723-14-0	0.01	0.03	0.05
	Copper alloy	Nickel (Ni) - cas no. 7440-02-0	7440-02-0	0.01	0.03	0.05
	Copper alloy	Iron (Fe)	7439-89-6	0.04	0.1	0.17
	Copper alloy	Copper (Cu)	7440-50-8	38.31	99.84	173.92
			Subtotal	38.37	100	174.19
Mould Compound	Polymer	Phenol Formaldehyde resin (generic)	9003-35-4	2.22	3.8	10.09
	Polymer	Epichlorohydrin/Diethyleneglycol Epoxy resin (generic)	25928-94-3	3.51	6.0	15.93
	Filler	Silica fused	60676-86-0	52.66	90.0	239.02
	Carbon Black	Carbon black	1333-86-4	0.12	0.2	0.53
			Subtotal	58.51	100	265.57
Post-plating	Pure metal	Tin (Sn)	7440-31-5	2.64	100.0	12
			Subtotal	2.64	100	12
Die Attach		1.6-bis(2.3-epoxypropoxy)hexane	16096-31-4	0	5.0	0
		Diethylene Glycol Monoethyl Ether Acetate	112-15-2	0	5.0	0
	Lead alloy	Silver (Ag)	7440-22-4	0	90.0	0
			Subtotal	0	100	0
			Total	99.99	100	453.92

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